

Current Mode Control

Internal 1.8A MOSFET Switching Regulator IC for Buck Converter

■ GENERAL DESCRIPTION

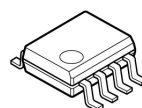
The **NJW4155** is a buck converter with **40V/1.8A** MOSFET. It corresponds to high oscillating frequency, and Low ESR Output Capacitor (MLCC) within wide input range from 4.5V to 40V.

Therefore, the **NJW4155** can realize downsizing of applications with a few external parts so that adopts current mode control.

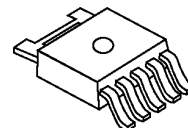
Also, it has a soft start function, external clock synchronization, over current protection and thermal shutdown circuit.

It is suitable for supplying power to a Car Accessory, Office Automation Equipment, Industrial Instrument and so on.

■ PACKAGE OUTLINE



NJW4155GM1



NJW4155DL3

■ FEATURES

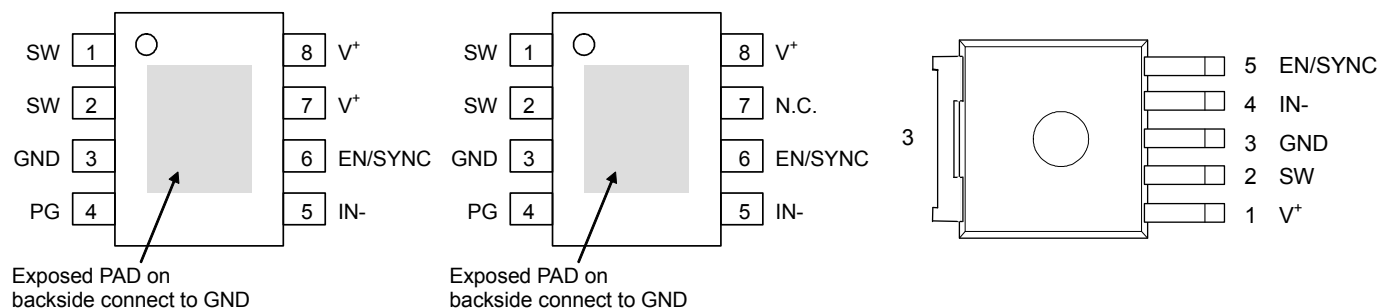
- Current Mode Control
- External Clock Synchronization
- Wide Operating Voltage Range 4.5V to 40V
- Switching Current 2.7A min.
- PWM Control
- Built-in Compensation Circuit
- Correspond to Ceramic Capacitor (MLCC)
- Oscillating Frequency 450kHz typ. (A, C ver.)
300kHz typ. (B ver.)
- Soft Start Function 4ms typ.
- UVLO (Under Voltage Lockout)
- Over Current Protection (Hiccup type)
- Thermal Shutdown Protection
- Power Good Function (NJW4155GM1 only)
- Standby Function
- Package Outline NJW4155GM1 : HSOP8
NJW4155DL3 : TO-252-5

NJW4155

■ PRODUCT CLASSIFICATION

Part Number	Version	Oscillation Frequency	Power Good	Package	Operating Temperature Range
NJW4155GM1-A	A	450kHz typ.	√	HSOP8	General Spec. Ta=-40°C to +125°C
NJW4155GM1-B	B	300kHz typ.	√	HSOP8	General Spec. Ta=-40°C to +125°C
NJW4155DL3-B	B	300kHz typ.		TO-252-5	General Spec. Ta=-40°C to +125°C
NJW4155GM1-C	C	450kHz typ.	√	HSOP8 (7pin: N.C.)	General Spec. Ta=-40°C to +125°C

■ PIN CONFIGURATION



NJW4155GM1-A
NJW4155GM1-B

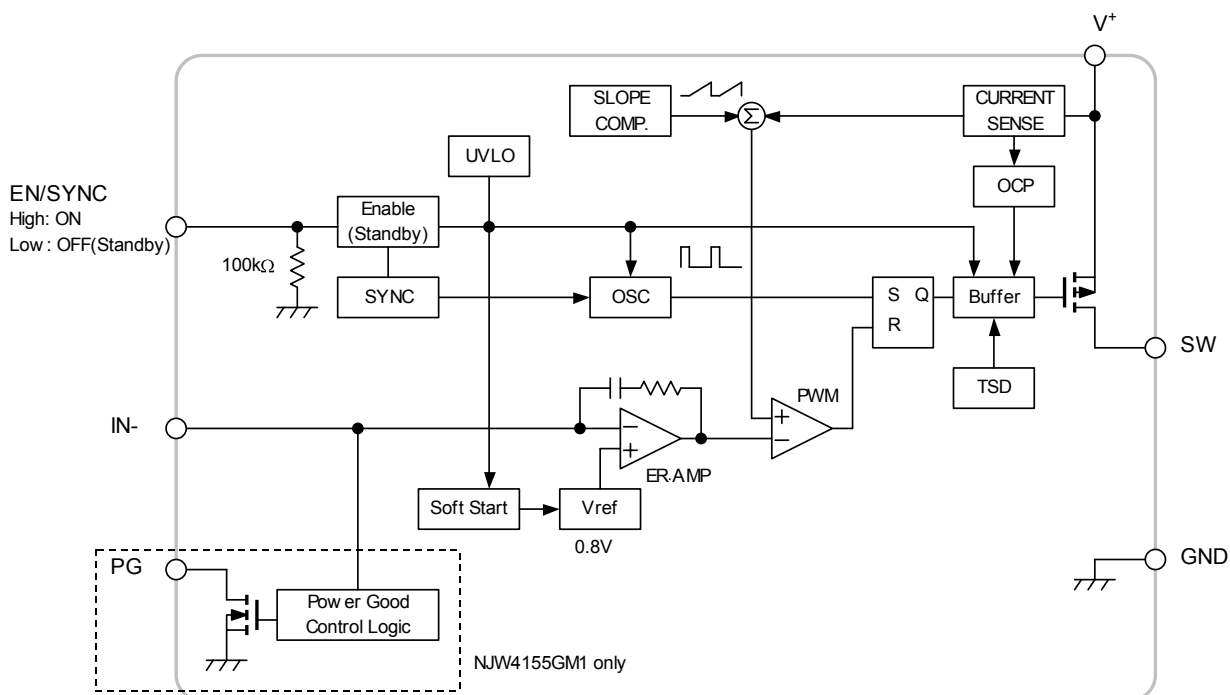
NJW4155GM1-C

NJW4155DL3-B

■ PIN DESCRIPTIONS

PIN NAME	PIN NUMBER			FUNCTION
	HSOP8	HSOP8	TO-252-5	
	A ver. B ver.	C ver.	B ver.	
SW	1 2	1 2	2	Switch Output pin of Power MOSFET
GND	3	3	3	GND pin
PG	4	4	—	Power Good pin. An open drain output that goes high impedance when the IN- pin voltage is stable around $\pm 10\%$. (Only HSOP8 PKG)
IN-	5	5	4	Output Voltage Detecting pin Connects output voltage through the resistor divider tap to this pin in order to voltage of the IN- pin become 0.8V.
EN/SYNC	6	6	5	Standby Control pin The EN/SYNC pin internally pulls down with 100k Ω . Normal Operation at the time of High Level. Standby Mode at the time of Low Level or OPEN. Moreover, it operates by inputting clock signal at the oscillatory frequency that synchronized with the input signal.
N.C.	—	7	—	Non Connection
V ⁺	7 8	8	1	Power Supply pin for Power Line
Exposed PAD	—	—	—	Connect to GND (Only HSOP8 PKG)

■ BLOCK DIAGRAM



■ ABSOLUTE MAXIMUM RATINGS

(Ta=25°C)

PARAMETER	SYMBOL	MAXIMUM RATINGS	UNIT
Supply Voltage	V ⁺	-0.3~+45	V
V ⁺ - SW pin Voltage	V _{V-SW}	+45	V
EN/SYNC pin Voltage	V _{EN/SYNC}	-0.3~+45	V
IN- pin Voltage	V _{IN-}	-0.3~+6	V
Power Good pin Voltage (*1)	V _{PG}	-0.3~+6	V
Power Dissipation	P _D	HSOP8 790 (*2) 2,500 (*3) TO-252-5 1,190 (*4) 3,125 (*3)	mW
Junction Temperature Range	T _j	-40 to +150	°C
Operating Temperature Range	T _{opr}	-40 to +125	°C
Storage Temperature Range	T _{stg}	-50 to +150	°C

(*1): Apply only the NJW4155GM1.

(*2): Mounted on glass epoxy board. (76.2×114.3×1.6mm:based on EIA/JDEC standard, 2Layers)

(*3): Mounted on glass epoxy board. (76.2×114.3×1.6mm:based on EIA/JDEC standard, 4Layers)

(For 4Layers: Applying 74.2×74.2mm inner Cu area and a thermal via hole to a board based on JEDEC standard JESD51-5)

(*4): Mounted on glass epoxy board. (76.2×114.3×1.6mm:based on EIA/JDEC standard size, 2Layers, Cu area 100mm²)

■ RECOMMENDED OPERATING CONDITIONS

PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT
Supply Voltage	V ⁺	4.5	—	40	V
Power Good pin Voltage (*5)	V _{PG}	0	—	5.5	V
External Clock Input Range	f _{SYNC}	440	—	600	kHz
A, C version					
B version		280	—	500	

(*5): Apply only the NJW4155GM1.

■ ELECTRICAL CHARACTERISTICS

(Unless otherwise noted, $V^+ = V_{EN/SYNC} = 12V$, $T_a = 25^\circ C$)

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
-----------	--------	----------------	------	------	------	------

Under Voltage Lockout Block

ON Threshold Voltage	V_{T_ON}	$V^+ = L \rightarrow H$	4.2	4.4	4.5	V
OFF Threshold Voltage	V_{T_OFF}	$V^+ = H \rightarrow L$	4.1	4.3	4.4	V
Hysteresis Voltage	V_{HYS}		70	90	–	mV

Soft Start Block

Soft Start Time	T_{SS}	$V_B = 0.75V$	2	4	8	ms
-----------------	----------	---------------	---	---	---	----

Oscillator Block

Oscillation Frequency	f_{OSC}	A, C version, $V_{IN} = 0.7V$	405	450	495	kHz
		B version, $V_{IN} = 0.7V$	270	300	330	kHz
Oscillation Frequency deviation (Supply voltage)	f_{DV}	$V^+ = 4.5V$ to $40V$	–	1	–	%
Oscillation Frequency deviation (Temperature)	f_{DT}	$T_a = -40^\circ C$ to $+85^\circ C$	–	5	–	%

Error Amplifier Block

Reference Voltage	V_B		-1.0%	0.8	+1.0%	V
Input Bias Current	I_B		-0.1	–	+0.1	μA

PWM Compare Block

Maximum Duty Cycle	M_{AXDUTY}	$V_{IN} = 0.7V$	92	95.5	–	%
Minimum ON Time1 (Use Built-in Oscillator)	$t_{ON-min1}$	A, C version	–	150	200	ns
		B version	–	215	290	ns
Minimum ON Time2 (Use Ext CLK)	$t_{ON-min2}$	A, C version, $f_{SYNC} = 500kHz$	–	100	140	ns
		B version, $f_{SYNC} = 400kHz$	–	145	200	ns

OCP Block

COOL DOWN Time	t_{COOL}		–	75	–	ms
----------------	------------	--	---	----	---	----

Output Block

Output ON Resistance	R_{ON}	$I_{SW} = 1.5A$	–	0.2	0.4	Ω
Switching Current Limit	I_{LIM}		2.7	3.4	4.0	A
SW Leak Current	I_{LEAK}	$V_{EN/SYNC} = 0V$, $V^+ = 45V$, $V_{SW} = 0V$	–	–	3	μA

■ ELECTRICAL CHARACTERISTICS

(Unless otherwise noted, $V^+ = V_{\text{EN/SYNC}} = 12\text{V}$, $T_a = 25^\circ\text{C}$)

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
-----------	--------	----------------	------	------	------	------

Standby Control / Sync Block

EN/SYNC pin High Threshold Voltage	$V_{\text{THH_EN/SYNC}}$	$V_{\text{EN/SYNC}} = \text{L} \rightarrow \text{H}$	1.6	—	V^+	V
EN/SYNC pin Low Threshold Voltage	$V_{\text{THL_EN/SYNC}}$	$V_{\text{EN/SYNC}} = \text{H} \rightarrow \text{L}$	0	—	0.5	V
Input Bias Current (EN/SYNC pin)	I_{EN}	$V_{\text{EN/SYNC}} = 12\text{V}$	—	170	250	μA

Power Good Block (*6)

High Level Detection Voltage	$V_{\text{THH_PG}}$	Measured at IN- pin	105	110	115	%
Low Level Detection Voltage	$V_{\text{THL_PG}}$	Measured at IN- pin	85	90	95	%
Hysteresis Region	$V_{\text{HYS_PG}}$		—	2	—	%
Power Good ON Resistance	$R_{\text{ON_PG}}$	$I_{\text{PG}} = 10\text{mA}$	—	37	50	Ω
Leak Current at OFF State	$I_{\text{LEAK_PG}}$	$V_{\text{PG}} = 6\text{V}$	—	—	0.1	μA

General Characteristics

Quiescent Current	I_{DD}	A, C version, $R_{\text{L}} = \text{no load}$, $V_{\text{IN}} = 0.7\text{V}$	—	3.5	4.2	mA
		B version, $R_{\text{L}} = \text{no load}$, $V_{\text{IN}} = 0.7\text{V}$	—	3.0	3.6	mA
Standby Current	$I_{\text{DD_STB}}$	$V_{\text{EN/SYNC}} = 0\text{V}$	—	—	3	μA

(*6): Apply only the NJW4155GM1.

■ THERMAL CHARACTERISTICS

PARAMETER	SYMBOL	VALUE		UNIT
Junction-to-ambient thermal resistance	θ_{ja}	HSOP8	158 (*7) 50 (*8)	°C/W
		TO-252-5	105 (*9) 40 (*8)	
Junction-to-Top of package characterization parameter	ψ_{jt}	HSOP8	28 (*7) 12 (*8)	°C/W
		TO-252-5	17 (*9) 12 (*8)	

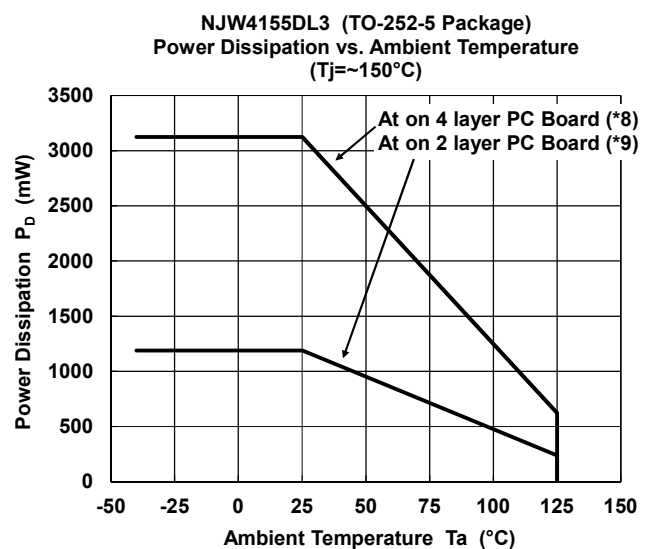
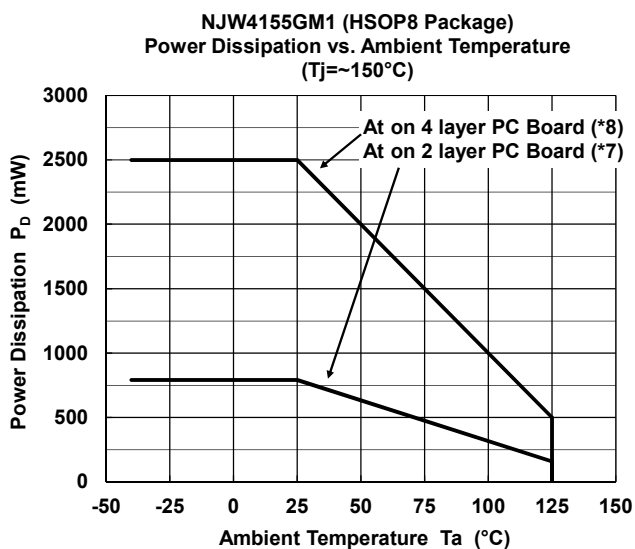
(*7): Mounted on glass epoxy board. (76.2×114.3×1.6mm:based on EIA/JDEC standard, 2Layers)

(*8): Mounted on glass epoxy board. (76.2×114.3×1.6mm:based on EIA/JDEC standard, 4Layers)

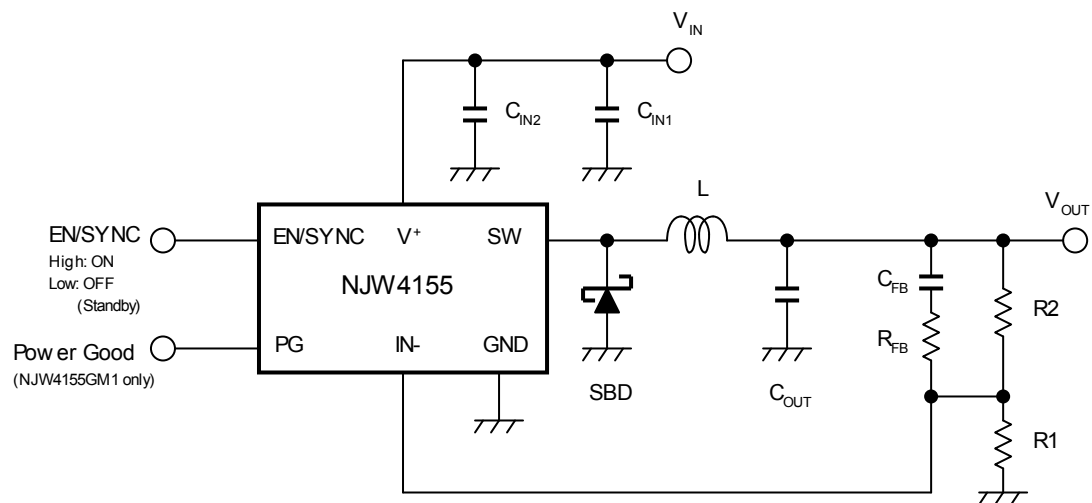
(For 4Layers: Applying 74.2×74.2mm inner Cu area and a thermal via hole to a board based on JEDEC standard JESD51-5)

(*9): Mounted on glass epoxy board. (76.2×114.3×1.6mm:based on EIA/JDEC standard size, 2Layers, Cu area 100mm²)

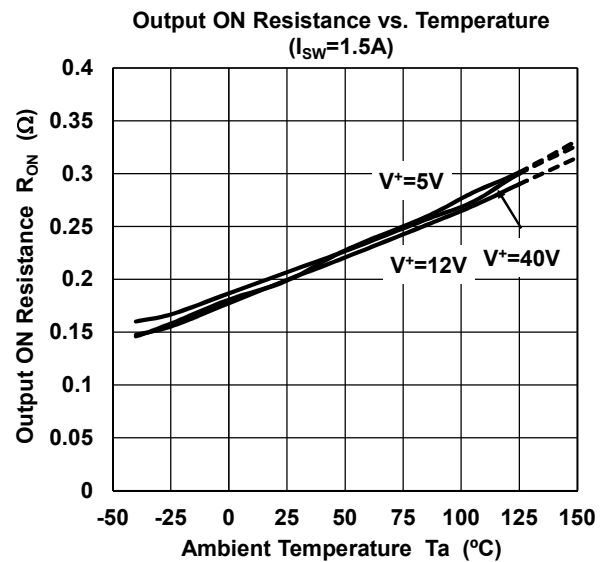
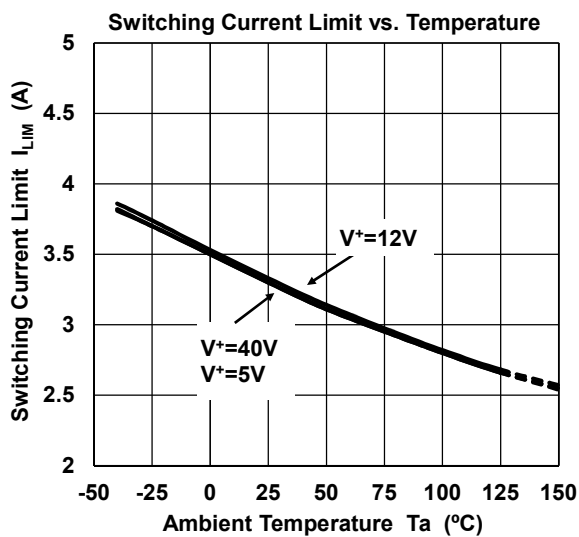
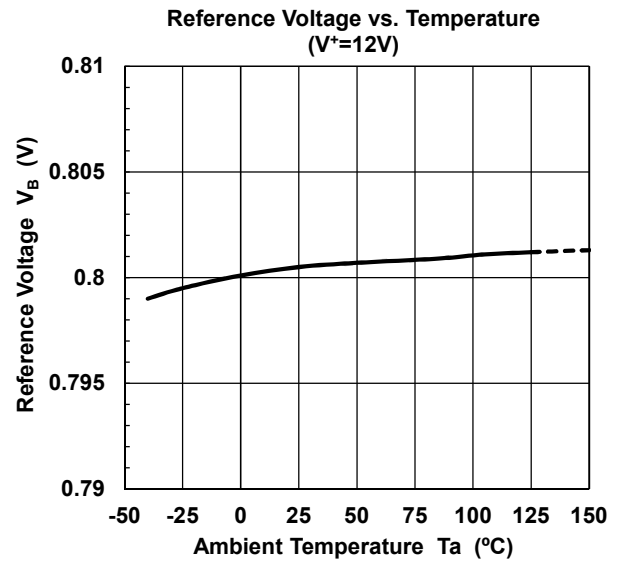
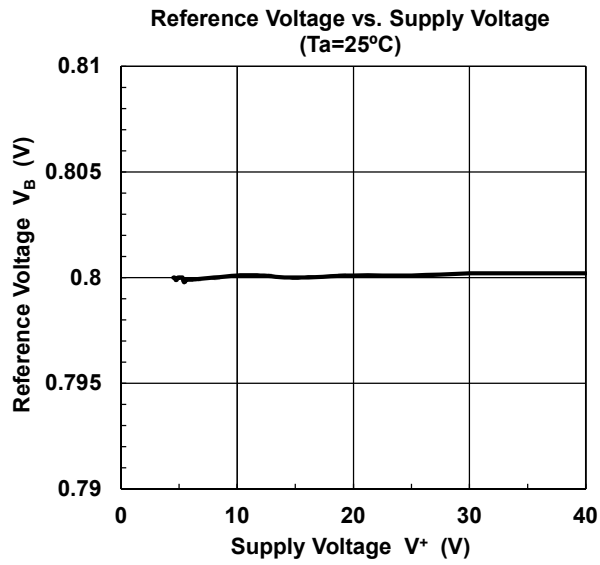
■ POWER DISSIPATION vs. AMBIENT TEMPERATURE



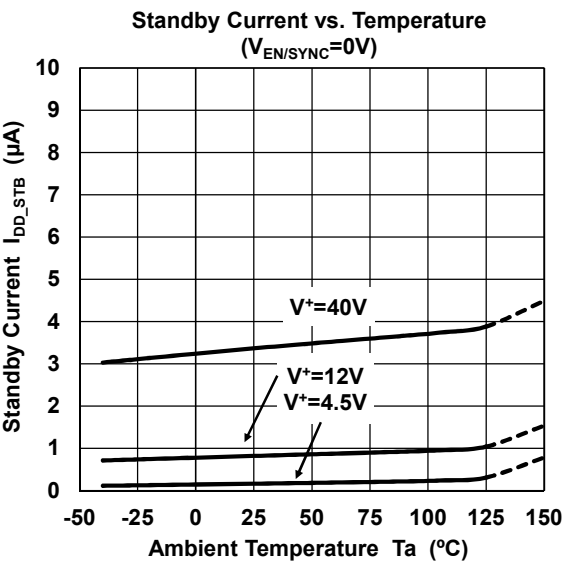
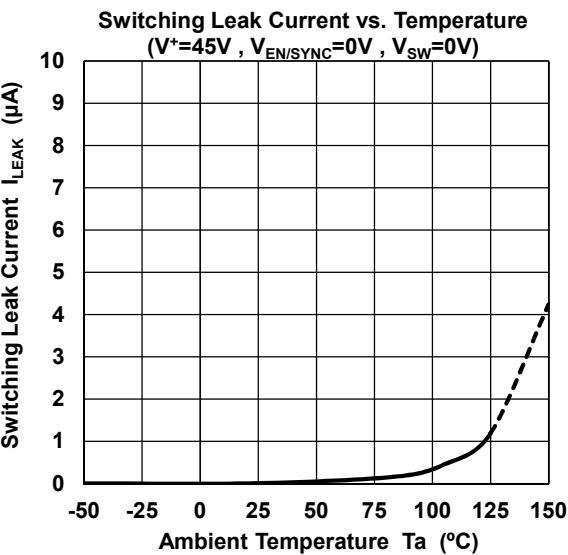
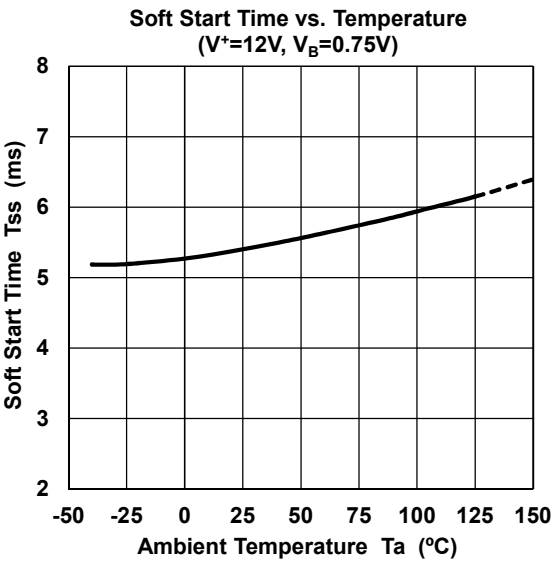
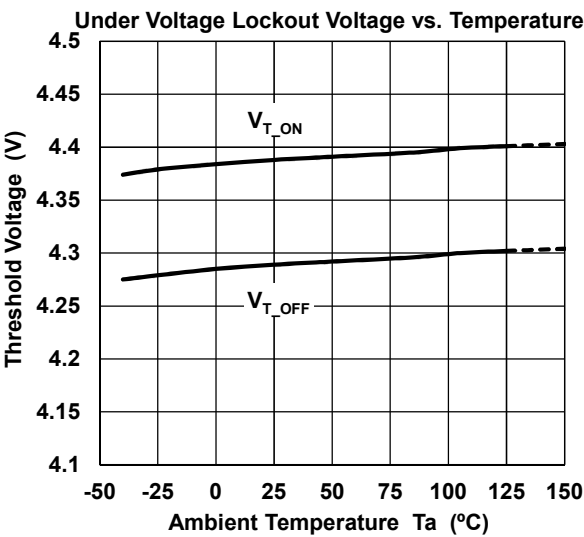
■ TYPICAL APPLICATIONS



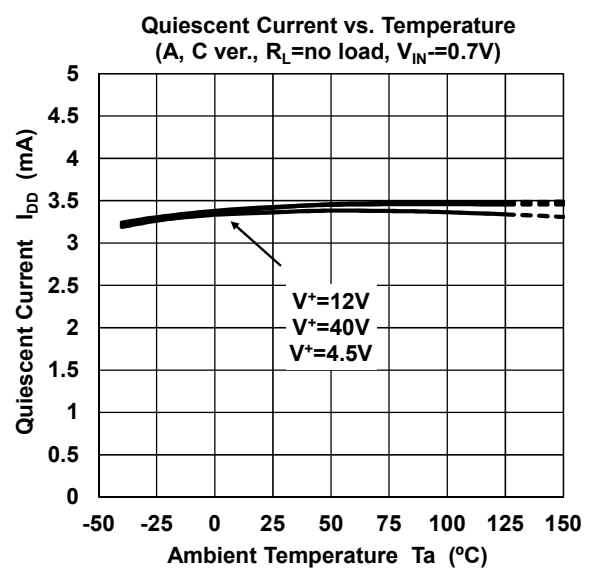
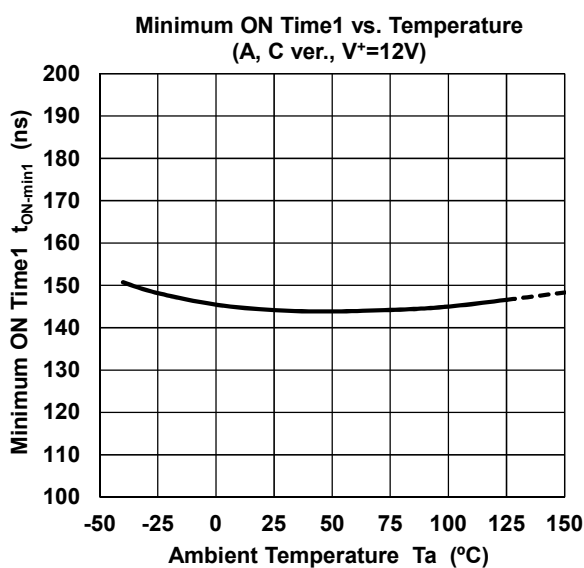
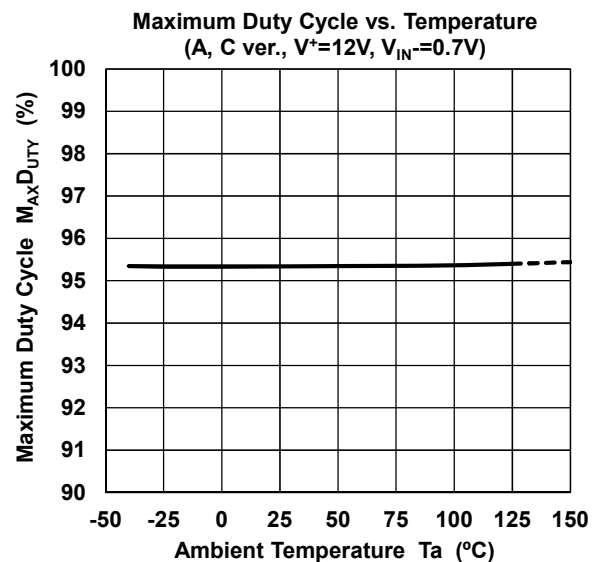
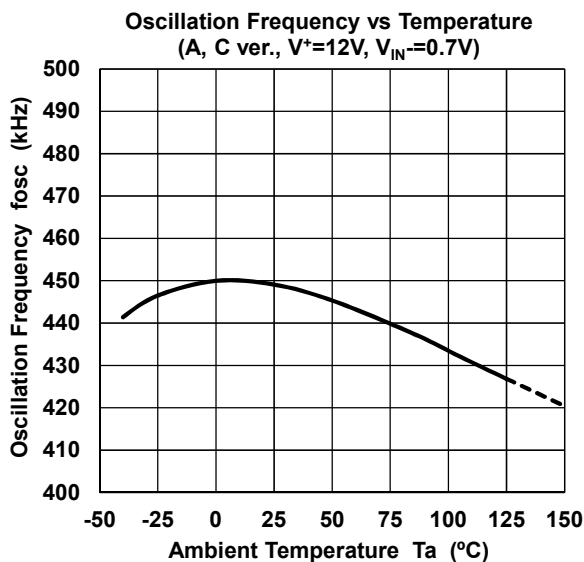
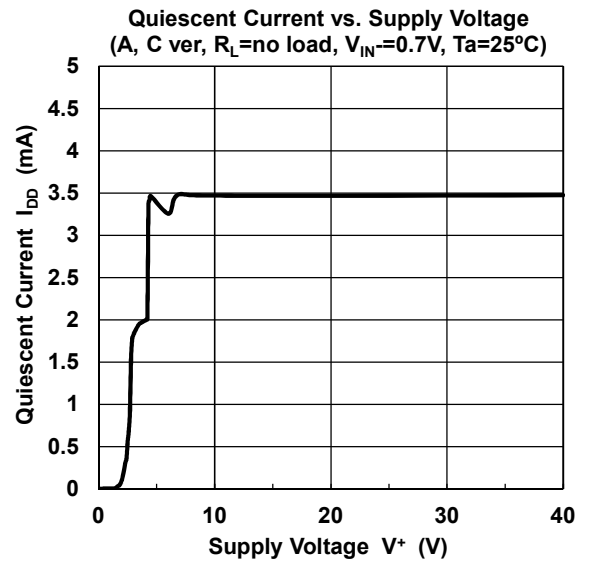
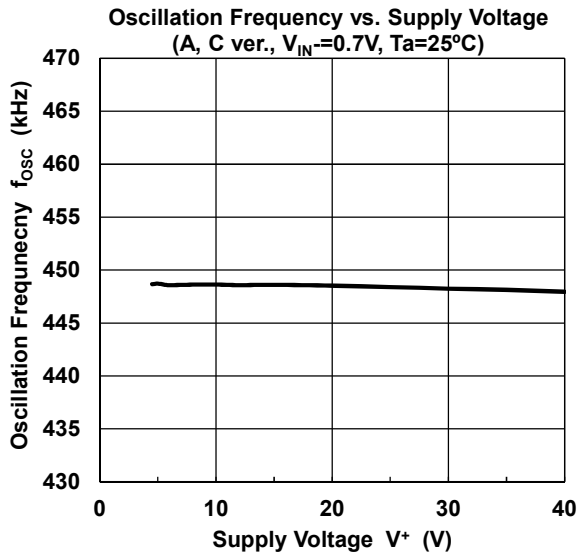
■ TYPICAL CHARACTERISTICS (A, B, C version)



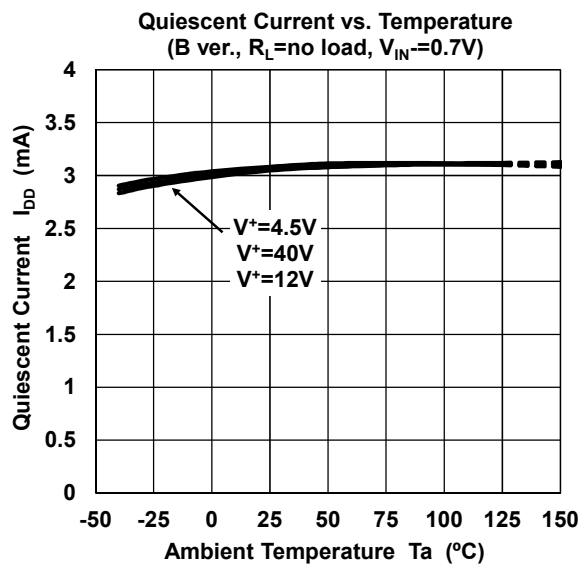
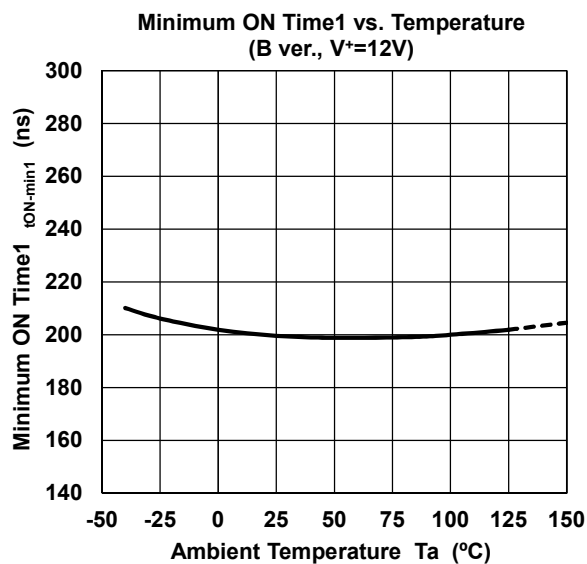
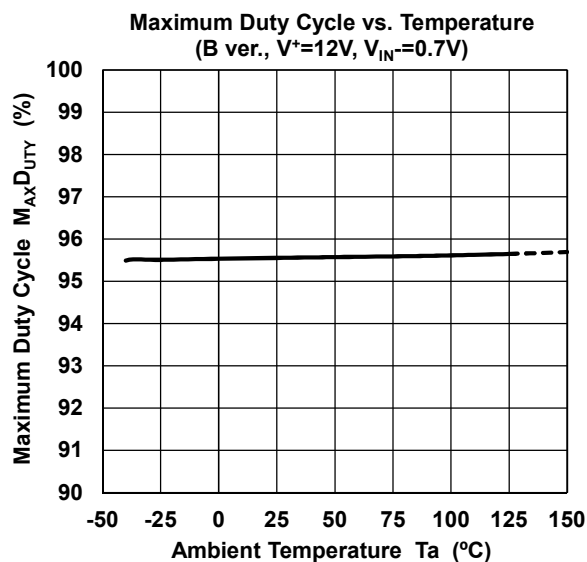
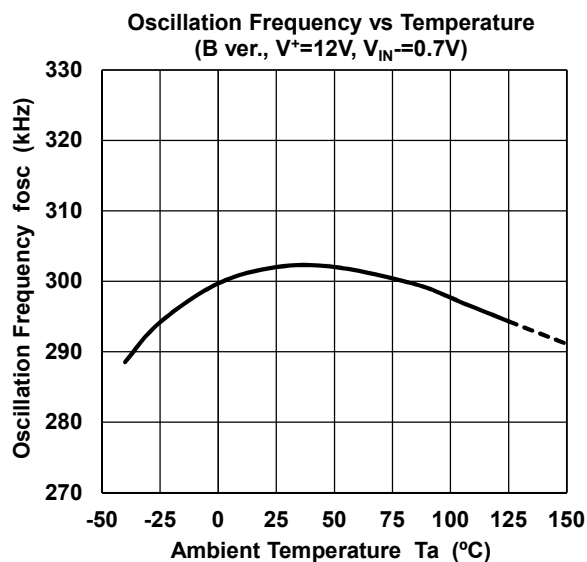
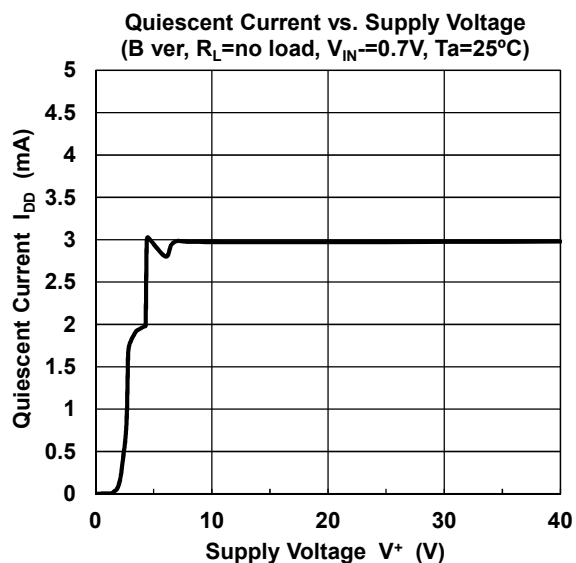
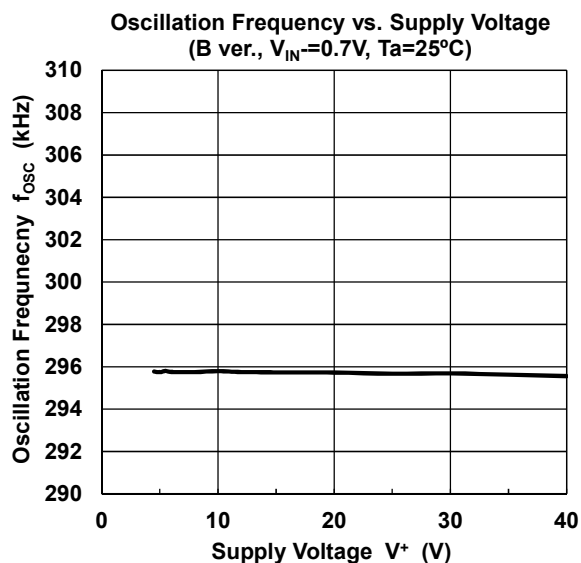
■ TYPICAL CHARACTERISTICS (A, B, C version)



■ TYPICAL CHARACTERISTICS (A, C version)



■ TYPICAL CHARACTERISTICS (B version)



■ Description of Block Features

1. Basic Functions / Features

● Error Amplifier Section (ER-AMP)

0.8V±1% precise reference voltage is connected to the non-inverted input of this section.

To set the output voltage, connects converter's output to inverted input of this section (IN- pin). If requires output voltage over 0.8V, inserts resistor divider.

Because the optimized compensation circuit is built-in, the application circuit can be composed of minimum external parts.

● PWM Comparator Section (PWM), Oscillation Circuit Section (OSC)

The NJW4155 uses a constant frequency, current mode step down architecture. The oscillation frequency is 450kHz (typ.) at A, C version and 300kHz (typ.) at B version. The PWM signal is output by feedback of output voltage and slope compensation switching current at the PWM comparator block.

The maximum duty ratio is 95.5% (typ.).

Table 1. Minimum ON time of NJW4155

	A, C version ($f_{OSC}=450\text{kHz}$)	B version ($f_{OSC}=300\text{kHz}$)
Use Built-in Oscillator	150ns typ.	215ns typ.
Use External Clock	100ns typ. (@ $f_{SYNC}=500\text{kHz}$)	145ns typ. (@ $f_{SYNC}=400\text{kHz}$)

The buck converter of ON time is decided the following formula.

$$t_{on} = \frac{V_{OUT}}{V_{IN} \times f_{OSC}} [s]$$

V_{IN} shows input voltage and V_{OUT} shows output voltage.

When the ON time becomes below in t_{ON-min} , in order to maintain output voltage at a stable state, change of duty or pulse skip operation may be performed.

● Power MOSFET (SW Output Section)

The power is stored in the inductor by the switch operation of built-in power MOSFET. The output current is limited to 2.7A(min.) the overcurrent protection function. In case of step-down converter, the forward direction bias voltage is generated with inductance current that flows into the external regenerative diode when MOSFET is turned off.

The SW pin allows voltage between the V^+ pin and the SW pin up to +45V. However, you should use an Schottky diode that has low saturation voltage.

● Power Supply, GND pin (V^+ and GND)

In line with switching element drive, current flows into the IC according to frequency. If the power supply impedance provided to the power supply circuit is high, it will not be possible to take advantage of IC performance due to input voltage fluctuation. Therefore insert a bypass capacitor close to the V^+ pin – the GND pin connection in order to lower high frequency impedance.

■ Description of Block Features (Continued)

2. Additional and Protection Functions / Features

● Under Voltage Lockout (UVLO)

The UVLO circuit operating is released above $V^+ = 4.4\text{V}(\text{typ.})$ and IC operation starts. When power supply voltage is low, IC does not operate because the UVLO circuit operates. There is $90\text{mV}(\text{typ.})$ width hysteresis voltage at rise and decay of power supply voltage. Hysteresis prevents the malfunction at the time of UVLO operating and releasing.

● Soft Start Function (Soft Start)

The output voltage of the converter gradually rises to a set value by the soft start function. The soft start time is $4\text{ms}(\text{typ.})$. It is defined with the time of the error amplifier reference voltage becoming from 0V to 0.75V . The soft start circuit operates after the release UVLO and/or recovery from thermal shutdown.

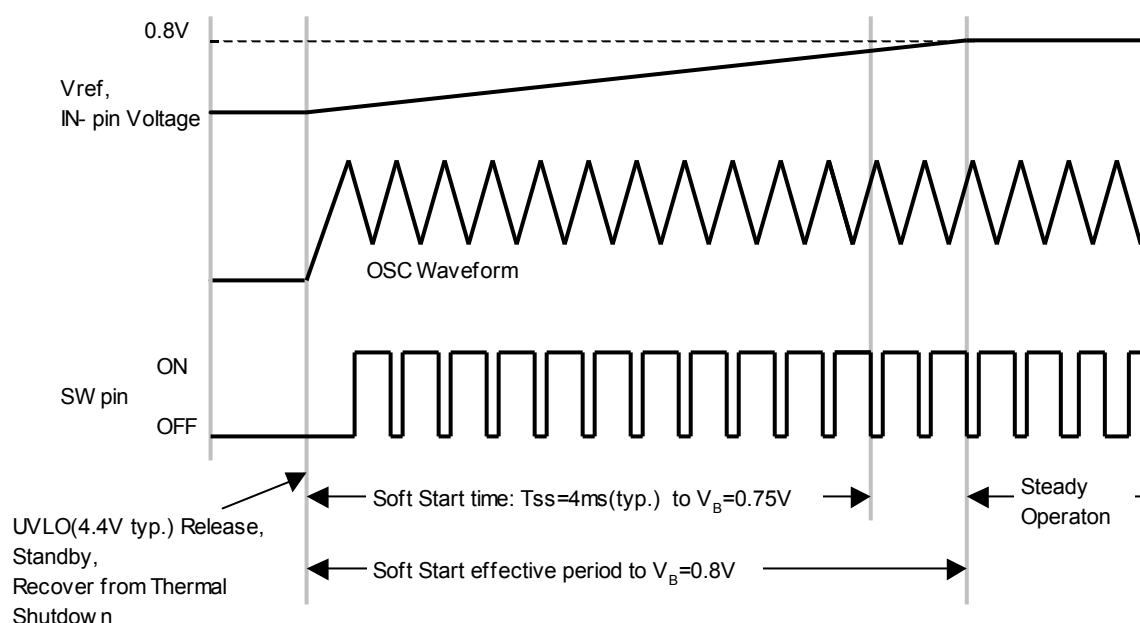


Fig. 1. Startup Timing Chart

■ Description of Block Features (Continued)

● Over Current Protection Circuit (OCP)

NJW4155 contains overcurrent protection circuit of hiccup architecture. The overcurrent protection circuit of hiccup architecture is able to decrease heat generation at the overload.

The NJW4155 output returns automatically along with release from the over current condition.

At when the switching current becomes I_{LIM} or more, the overcurrent protection circuit is stopped the MOSFET output. The switching output holds low level down to next pulse output at OCP operating.

When the IN- pin voltage is 0.5V or lower(less), the switching operation stops after the overcurrent detection continued 128 pulses.

After NJW4155 switching operation was stopped, it restarts by soft start function after the cool down time of approx 75ms (typ.).

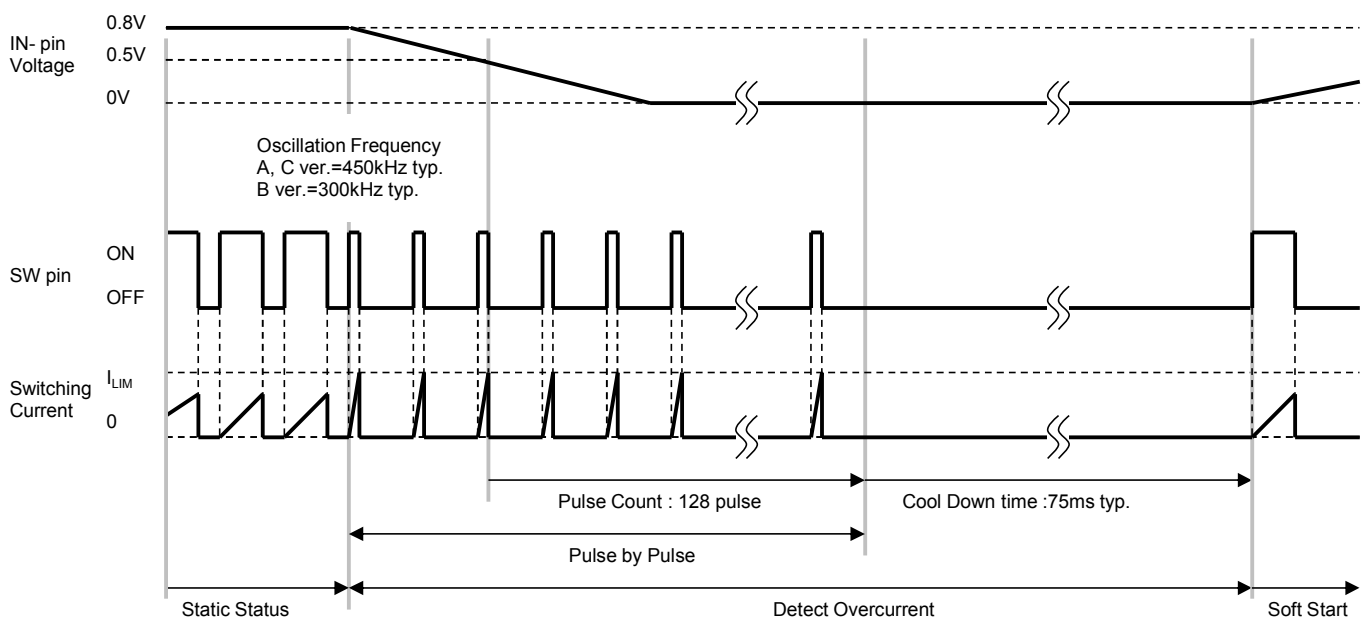


Fig. 2. Timing Chart at Over Current Detection

● Thermal Shutdown Function (TSD)

When Junction temperature of the NJW4155 exceeds the 160°C*, internal thermal shutdown circuit function stops SW function. When junction temperature decreases to 145°C* or less, SW operation returns with soft start operation.

The purpose of this function is to prevent malfunctioning of IC at the high junction temperature. Therefore it is not something that urges positive use. You should make sure to operate within the junction temperature range rated (150°C). (* Design value)

● Standby Function

The NJW4155 stops the operating and becomes standby status when the EN/SYNC pin becomes less than 0.5V.

The EN/SYNC pin internally pulls down with 100kΩ, therefore the NJW4155 becomes standby mode when the EN/SYNC pin is OPEN. You should connect this pin to V^+ when you do not use standby function.

■ Description of Block Features (Continued)

● External Clock Synchronization

By inputting a square wave to EN/SYNC pin, can be synchronized to an external frequency.

You should fulfill the following specification about a square wave. (Table 2.)

Table 2. The input square wave to an EN/SYNC pin.

	A, C version ($f_{OSC} = 450\text{kHz}$)	B version ($f_{OSC} = 300\text{kHz}$)
Input Frequency	440kHz to 600kHz	280kHz to 500kHz
Duty Cycle	25% to 75%	20% to 80%
Voltage magnitude	1.6V or more at High level 0.5V or less at Low level	

The trigger of the switching operating at the external synchronized mode is detected to the rising edge of the input signal. At the time of switching operation from standby or asynchronous to synchronous operation, it has set a delay time approx $20\mu\text{s}$ to $30\mu\text{s}$ in order to prevent malfunctions. (Fig. 3.)

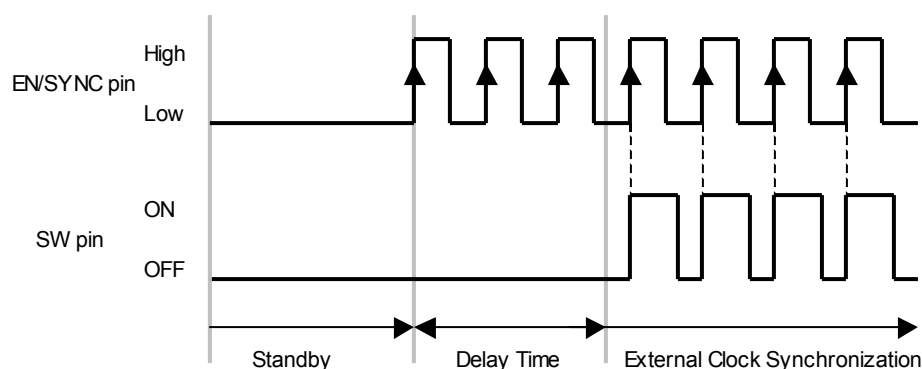


Fig. 3. Switching Operation by External Synchronized Clock

● Power Good Function

It monitors the output status and outputs a signal from PG pin that internally connected to open drain MOSFET.

The Power Good pin goes high impedance when the IN- pin voltage is stable around $\pm 10\%$ (typ.) of error amplifier reference voltage.

A low on the pin indicates that the IN- pin voltage is out of the setting voltage.

To prevent malfunction of the Power Good output, it has hysteresis 2%(typ.) and the delay time approx $20\mu\text{s}$ to $30\mu\text{s}$ against the IN- pin voltage changes.

■ Application Information

● Inductors

Because a large current flows to the inductor, you should select the inductor with the large current capacity not to saturate. Optimized inductor value is determined by the input voltage and output voltage.

The Inductor setting example is shown in Table 3.

Table 3. Inductor Setting Example

Input Voltage V_{IN}	Output Voltage V_{OUT}	Inductor L	
		A, C version ($f_{OSC} = 450\text{kHz}$)	B version ($f_{OSC} = 300\text{kHz}$)
12V	3.3V	$\leq 27\mu\text{H}$	$\leq 39\mu\text{H}$
	5.0V	$\leq 33\mu\text{H}$	$\leq 47\mu\text{H}$
	8.0V	$\leq 33\mu\text{H}$	$\leq 47\mu\text{H}$
24V	3.3V	$\leq 39\mu\text{H}$	$\leq 47\mu\text{H}$
	5.0V	$\leq 47\mu\text{H}$	$\leq 56\mu\text{H}$
	8.0V	$\leq 47\mu\text{H}$	$\leq 56\mu\text{H}$

When increasing inductor value, it is necessary to increasing capacity of an output capacitor and to secure the stability of application. The minimum of inductor value is restricted from the following formula, when ON duty exceeds 50%.

$$\text{A, C version } L \geq \frac{V_{IN} \times (2 \times D_{ON} - 1)}{1.11} [\mu\text{H}]$$

$$\text{B version } L \geq \frac{V_{IN} \times (2 \times D_{ON} - 1)}{0.74} [\mu\text{H}]$$

Reducing L decreases the size of the inductor. However a peak current increases and adversely affects the efficiency. (Fig. 4.)

Moreover, you should be aware that the output current is limited because it becomes easy to operating to the overcurrent limit.

The peak current is decided the following formula.

$$\Delta I_L = \frac{(V_{IN} - V_{OUT}) \times V_{OUT}}{L \times V_{IN} \times f_{OSC}} [\text{A}]$$

$$I_{pk} = I_{OUT} + \frac{\Delta I_L}{2} [\text{A}]$$

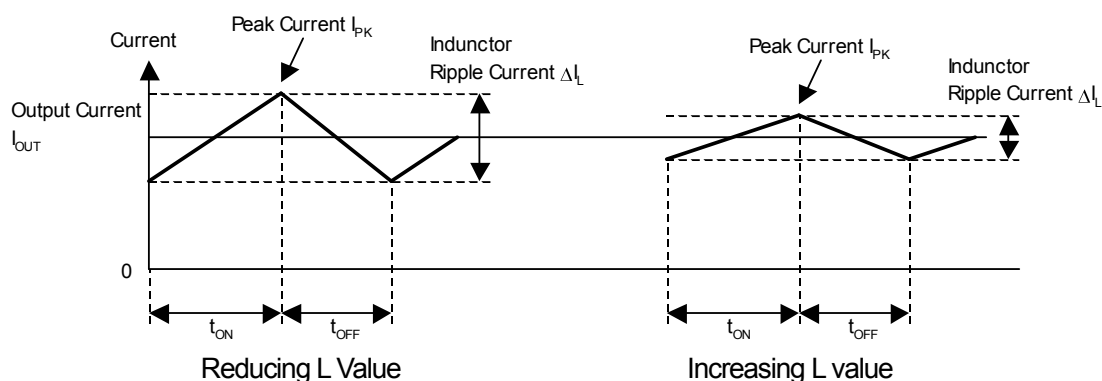


Fig. 4. Inductor Current State Transition (Continuous Conduction Mode)

■ Application Information (Continued)

● Input Capacitor

Transient current flows into the input section of a switching regulator responsive to frequency. If the power supply impedance provided to the power supply circuit is large, it will not be possible to take advantage of the NJW4155 performance due to input voltage fluctuation. Therefore insert an input capacitor as close to the MOSFET as possible. A ceramic capacitor is the optimal for input capacitor.

The effective input current can be expressed by the following formula.

$$I_{RMS} = I_{OUT} \times \frac{\sqrt{V_{OUT} \times (V_{IN} - V_{OUT})}}{V_{IN}} [A]$$

In the above formula, the maximum current is obtained when $V_{IN} = 2 \times V_{OUT}$, and the result in this case is

$$I_{RMS} = I_{OUT(MAX)} \div 2.$$

When selecting the input capacitor, carry out an evaluation based on the application, and use a capacitor that has adequate margin.

● Output Capacitor

An output capacitor stores power from the inductor, and stabilizes voltage provided to the output.

Because NJW4155 corresponds to the output capacitor of low ESR, the ceramic capacitor is the optimal for compensation. The output capacitor setting example is shown in Table 4.

Table 4. Output Capacitor Setting Example

Input Voltage V_{IN}	Output Voltage V_{OUT}	Capacitor C_{OUT}	Part Number
A, C version			
12V, 24V	3.3V	$\geq 47\mu F / 6.3V$	GRM31CB30J476KE18: Murata
	5.0V	$\geq 22\mu F / 6.3V$	GRM31CB30J226ME18: Murata
	8.0V	$\geq 22\mu F / 10V$	GRM31CR61A226ME19: Murata
B version			
12V, 24V	3.3V	$\geq 47\mu F / 6.3V + 22\mu F / 6.3V$	GRM31CB30J476KE18: Murata GRM31CB30J226ME18: Murata
	5.0V	$\geq 47\mu F / 6.3V$	GRM31CB30J476KE18: Murata
	8.0V	$\geq 47\mu F / 16V$	GRM32EB31C476KE15: Murata

The output capacitor uses capacity bigger than Table 4.

In addition, you should consider varied characteristics of capacitor (a frequency characteristic, a temperature characteristic, a DC bias characteristic and so on) and unevenness peculiar to a capacitor supplier enough.

Therefore when selecting a capacitors, you should confirm the characteristics with supplier datasheets.

When selecting an output capacitor, you must consider Equivalent Series Resistance (ESR) characteristics, ripple current, and breakdown voltage.

The output ripple noise can be expressed by the following formula.

$$V_{ripple(p-p)} = ESR \times \Delta I_L [V]$$

The effective ripple current that flows in a capacitor (I_{rms}) is obtained by the following equation.

$$I_{rms} = \frac{\Delta I_L}{2\sqrt{3}} [Arms]$$

■ Application Information (Continued)

● Catch Diode

When the switch element is in OFF cycle, power stored in the inductor flows via the catch diode to the output capacitor. Therefore during each cycle current flows to the diode in response to load current. Because diode's forward saturation voltage and current accumulation cause power loss, a Schottky Barrier Diode (SBD), which has a low forward saturation voltage, is ideal.

An SBD also has a short reverse recovery time. If the reverse recovery time is long, through current flows when the switching transistor transitions from OFF cycle to ON cycle. This current may lower efficiency and affect such factors as noise generation.

● Setting Output Voltage, Compensation Capacitor

The output voltage V_{OUT} is determined by the relative resistances of R1, R2. The current that flows in R1, R2 must be a value that can ignore the bias current that flows in ER AMP.

$$V_{OUT} = \left(\frac{R2}{R1} + 1 \right) \times V_B \text{ [V]}$$

The zero points are formed with R2 and C_{FB} , and it makes for the phase compensation of NJW4155. The zero point is shown the following formula.

$$f_{z1} = \frac{1}{2 \times \pi \times R2 \times C_{FB}} \text{ [Hz]}$$

You should set the zero point as a guide from 50kHz to 70kHz.

Output voltage setting resistor and compensation capacitor setting example is shown in Table 5.

Table 5. Output Voltage Setting Resistor and Compensation Capacitor Setting Example

Input Voltage V_{IN}	Output Voltage V_{OUT}	R1	R2	C_{FB}
12V, 24V	3.3V	4.7k Ω	15k Ω	180pF
	5.0V	3.0k Ω	16k Ω	150pF
	8.0V	2.2k Ω	20k Ω	120pF

(A version, B version and C version are common.)

■ Application Information (Continued)

● Board Layout

In the switching regulator application, because the current flow corresponds to the oscillation frequency, the substrate (PCB) layout becomes an important.

You should attempt the transition voltage decrease by making a current loop area minimize as much as possible. Therefore, you should make a current flowing line thick and short as much as possible. Fig.5. shows a current loop at step-down converter. Especially, should lay out high priority the loop of C_{IN} -SW-SBD that occurs rapid current change in the switching. It is effective in reducing noise spikes caused by parasitic inductance.

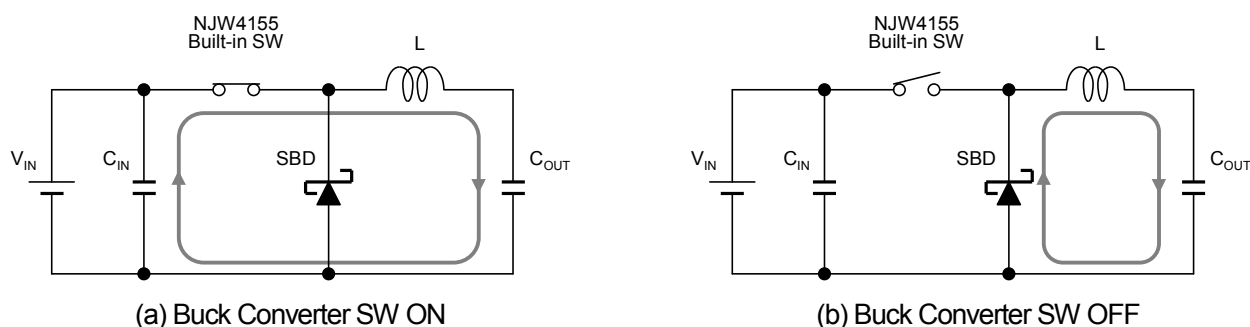


Fig. 5. Current Loop at Buck Converter

Concerning the GND line, it is preferred to separate the power system and the signal system, and use single ground point.

The voltage sensing feedback line should be as far away as possible from the inductance. Because this line has high impedance, it is laid out to avoid the influence noise caused by flux leaked from the inductance.

Fig. 6. shows example of wiring at buck converter. Fig. 7 shows the PCB layout example.

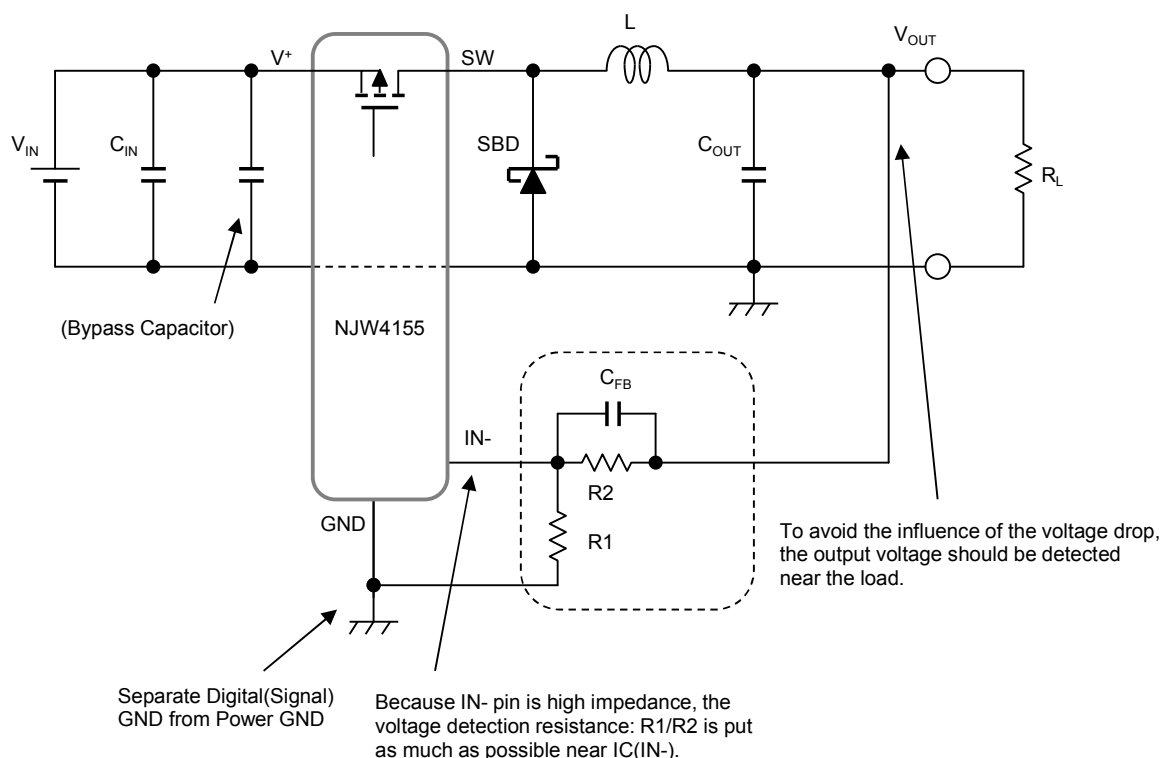
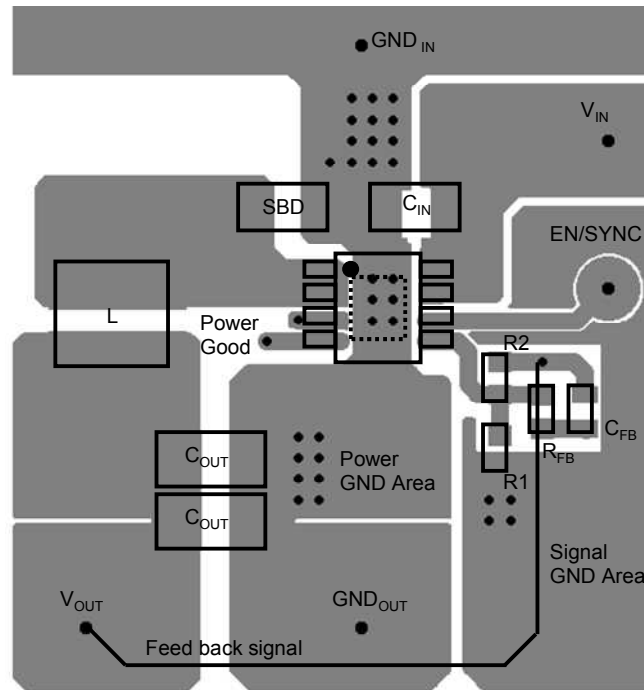


Fig. 6. Board Layout at Buck Converter

■ Application Information (Continued)



HSOP8 Package (A version and B version)

Connect Signal GND line and Power GND line on backside pattern

Fig. 7. Layout Example (upper view)

■ Calculation of Package Power

A lot of the power consumption of buck converter occurs from the internal switching element (Power MOSFET). Power consumption of NJW4155 is roughly estimated as follows.

$$\begin{aligned}\text{Input Power:} & P_{\text{IN}} = V_{\text{IN}} \times I_{\text{IN}} \quad [\text{W}] \\ \text{Output Power:} & P_{\text{OUT}} = V_{\text{OUT}} \times I_{\text{OUT}} \quad [\text{W}] \\ \text{Diode Loss:} & P_{\text{DIODE}} = V_{\text{F}} \times I_{\text{L(avg)}} \times \text{OFF duty} \quad [\text{W}] \\ \text{NJW4155 Power Consumption:} & P_{\text{LOSS}} = P_{\text{IN}} - P_{\text{OUT}} - P_{\text{DIODE}} \quad [\text{W}]\end{aligned}$$

Where:

V_{IN}	: Input Voltage for Converter	I_{IN}	: Input Current for Converter
V_{OUT}	: Output Voltage of Converter	I_{OUT}	: Output Current of Converter
V_{F}	: Diode's Forward Saturation Voltage	$I_{\text{L(avg)}}$	: Inductor Average Current
OFF duty	: Switch OFF Duty		

Efficiency (η) is calculated as follows.

$$\eta = (P_{\text{OUT}} \div P_{\text{IN}}) \times 100 \quad [\%]$$

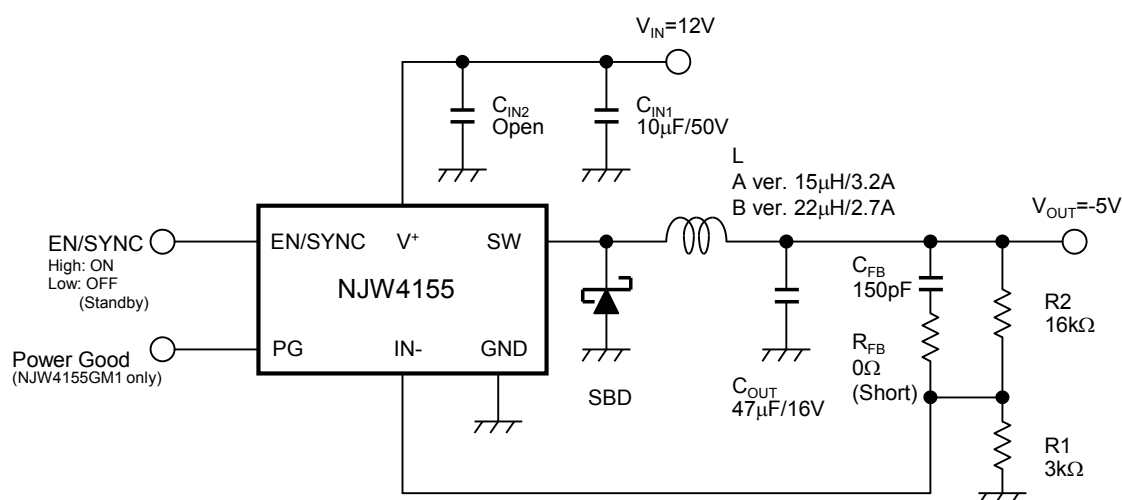
You should consider temperature derating to the calculated power consumption: P_{D} .

You should design power consumption in rated range referring to the power dissipation vs. ambient temperature characteristics.

■ Application Design Examples

● Buck Converter Application Circuit

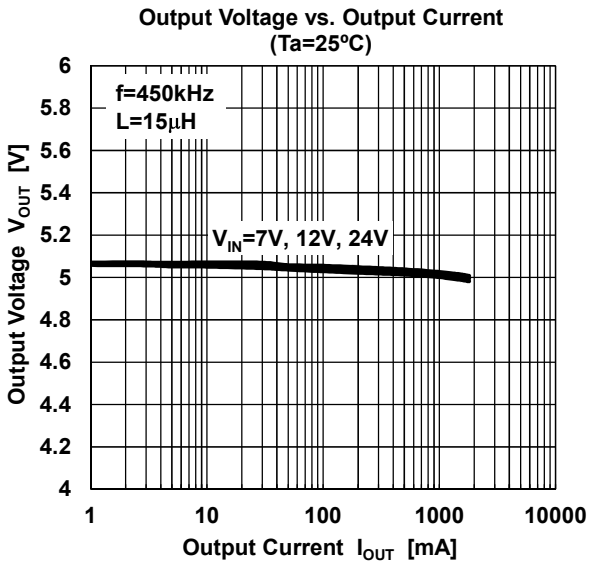
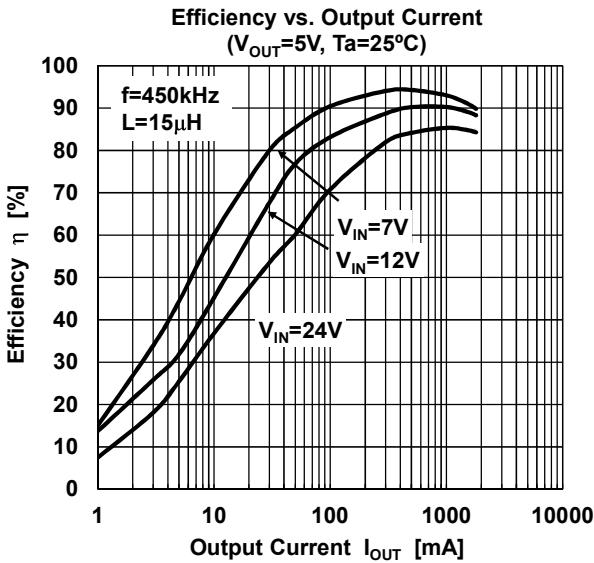
IC : NJW4155GM1
 Input Voltage : $V_{IN}=12V$
 Output Voltage : $V_{OUT}=5V$
 Output Current : $I_{OUT}=1.8A$
 Oscillation frequency : A, C version $f_{osc}=450kHz$
 : B version $f_{osc}=300kHz$



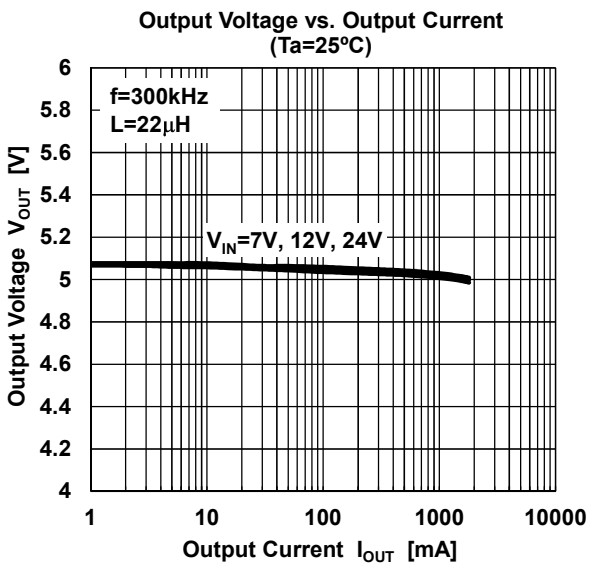
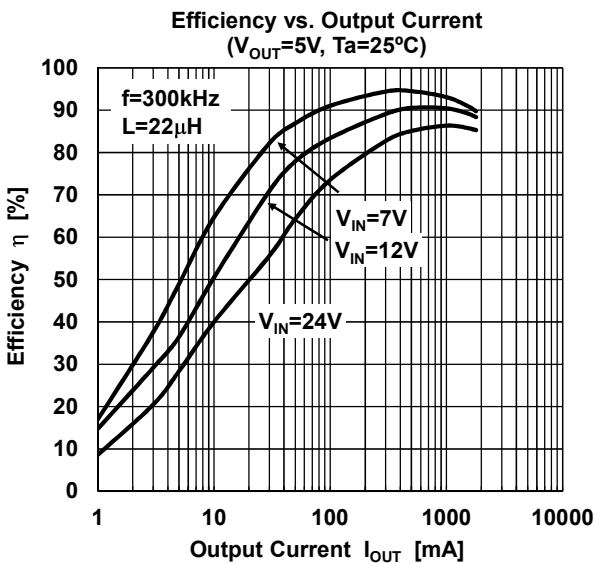
Reference	Qty.	Part Number	Description	Manufacturer
IC	1	NJW4155GM1	Internal 1.8A MOSFET SW.REG. IC	New JRC
L	1	A, C ver.: CLF10040T-150M	Inductor 15μH, 3.2A	TDK
		B ver.: CLF10040T-220M	Inductor 22μH, 2.7A	TDK
SBD	1	CMS16	Schottky Diode 40V, 3A	Toshiba
C _{IN1}	1	UMK325BJ106MM	Ceramic Capacitor 3225 10μF, 50V, X5R	Taiyo Yuden
C _{IN2}	1	Open	Optional	—
C _{OUT}	1	GRM32EB31C476KE15	Ceramic Capacitor 3225 47μF, 16V, B	Murata
C _{FB}	1	150pF	Ceramic Capacitor 1608 150pF, 50V, CH	Std.
R _{FB}	1	0Ω (Short)	Optional	—
R1	1	3kΩ	Resistor 1608 3kΩ, ±1%, 0.1W	Std.
R2	1	16kΩ	Resistor 1608 16kΩ, ±1%, 0.1W	Std.

■ Application Characteristics

● A, C version



● B version



MEMO

[CAUTION]
The specifications on this databook are only given for information, without any guarantee as regards either mistakes or omissions. The application circuits in this databook are described only to show representative usages of the product and not intended for the guarantee or permission of any right including the industrial rights.

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

[NJR:](#)

[NJW4155DL3-B-TE1](#) [NJW4155GM1-B-TE2](#) [NJW4155GM1-A-TE2](#) [NJW4155GM1-A-TE1](#) [NJW4155DL3-B-TE2](#)
[NJW4155GM1-B-TE1](#)



Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

Телефон: 8 (812) 309 58 32 (многоканальный)

Факс: 8 (812) 320-02-42

Электронная почта: org@eplast1.ru

Адрес: 198099, г. Санкт-Петербург, ул. Калинина, дом 2, корпус 4, литера А.